

IAP12 Rec'd PCT/PTO 25 AUG 2006

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?::

None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?::

No

Number of copies of CRF::

Title ::

CONDUCTIVE PASTE FOR A MULTI-
LAYERED CERAMIC ELECTRONIC
COMPONENT AND A METHOD FOR
MANUFACTURING A MULTI-LAYERED UNIT
FOR A MULTI-LAYERED CERAMIC
ELECTRONIC COMPONENT

Attorney Docket Number::

890050.544USPC

Request for Early Publication?::

No

Request for Non-Publication?::

No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?::

No

Petition included?::

No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No.:

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Shigeki

Middle Name::

Family Name:: Satou

Name Suffix::

City of Residence:: Tokyo

State or Province of Residence::

Country of Residence:: Japan

Street of mailing address:: c/o TDK Corporation, 1-13-1,
Nihonbashi, Chuo-ku

City of mailing address:: Tokyo

State or Province of mailing address::

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 103-8272

Second Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Takeshi

Middle Name::

Family Name:: Nomura

Name Suffix::

City of Residence:: Tokyo
 State or Province of Residence::
 Country of Residence:: Japan
 Street of mailing address:: c/o TDK Corporation, 1-13-1,
 Nihonbashi, Chuo-ku
 City of mailing address:: Tokyo
 State or Province of mailing address::
 Country of mailing address:: Japan
 Postal or Zip Code of mailing address:: 103-8272

Correspondence Information

Correspondence Customer Number :: **00500**

Representative Information

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|----------------------------------|--|--------------|
| Representative Customer Number:: | | 00500 |
|----------------------------------|--|--------------|

Domestic Priority Information

| Application :: | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
|------------------|-------------------|----------------------|----------------------|
| This Application | National Stage of | PCT/JP2005/002881 | 02/23/05 |
| | | | |
| | | | |

Foreign Priority Information

| Country:: | Application number:: | Filing Date:: | Priority Claimed:: |
|-----------|----------------------|---------------|--------------------|
| Japan | 2004-054722 | 02/27/04 | Yes |
| | | | |

Assignee Information

| | |
|---|-----------------------------|
| Assignee name:: | TDK Corporation |
| Street of mailing address:: | 1-13-1, Nihonbashi, Chuo-ku |
| City of mailing address:: | Tokyo |
| State or Province of mailing address:: | |
| Country of mailing address:: | Japan |
| Postal or Zip Code of mailing address:: | 103-8272 |

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